

**AMENDMENT TO
RULES COMMITTEE PRINT 119-33
OFFERED BY MR. SOTO OF FLORIDA**

At the end of subtitle F of title XVII, add the following new section:

1 **SEC. 18__ . FUNDING FOR FAN-OUT WAFER LEVEL PACK-**
2 **AGING PROGRAM OF INDUSTRIAL BASE**
3 **ANALYSIS AND SUSTAINMENT PROGRAM.**

4 (a) INCREASE.—Notwithstanding the amounts set
5 forth in the funding tables in division D, the amount au-
6 thorized to be appropriated in section 201 for research,
7 development, test, and evaluation, Defense-wide, line 233,
8 as specified in the corresponding funding table in section
9 4201, is hereby increased by \$10,000,000 for the fan-out
10 wafer level packaging program of the Industrial Base
11 Analysis and Sustainment Program of the Department of
12 Defense.

13 (b) OFFSET.—Notwithstanding the amounts set forth
14 in the funding tables in division D, the amount authorized
15 to be appropriated in section 301 for operation and main-
16 tenance Defense-wide, line 480, as specified in the cor-
17 responding funding table in section 4301, for the Office

1 of the Secretary of Defense, is hereby reduced by
2 \$10,000,000.

